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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No.
Filing Date
Inventor
Assignee Micron Technology, Inc.
Group Art Unit 2827
Examiner David A. Zarneke
Attorney's Docket No. MI22-1572
Title: Methods of Forming Board-On-Chip Packages

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

References -See Attached Form PTO-1449

The Examiner's attention is directed to the reference which is listed on the attached Form PTO-1449, a copy of which is attached. No admission is made regarding whether the submitted reference is prior art.

Citation of the referenced art is respectfully requested.

Respectfully submitted,

Dated: 12-26-02

By: D. Brent Kenady
D. Brent Kenady
Reg. No. 40,045

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